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SCES809A - MARCH 2010-REVISED MAY 2010

16-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

Check for Samples: SN74AVCB164245-Q1

FEATURES

- Qualified for Automotive Applications
- Member of the Texas Instruments Widebus™
 Family
- DOC[™] Circuitry Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed Degradation
- Dynamic Drive Capability Is Equivalent to Standard Outputs With I_{OH} and I_{OL} of ±24 mA at 2.5-V V_{CC}
- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCB} Voltage
- If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State

- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- I_{off} Supports Partial-Power-Down Mode Operation
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over Full 1.4-V to 3.6-V Power-Supply Range
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 750-V Charged-Device Model (C101)

DESCRIPTION

This 16-bit (dual-octal) noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.4 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.4 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVCB164245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVCB164245 is designed so that the control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V_{CCB}.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CCB} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. If either V_{CC} input is at GND, both ports are in the high-impedance state.

ORDERING INFORMATION⁽¹⁾

| T _A | PACK | AGE ⁽²⁾ | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|--------------------|-----------------------|------------------|
| -40°C to 125°C | TSSOP - DGG | Tape and reel | CAVCB164245QDGGRQ1 | AVCB164245Q |

⁽¹⁾ For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

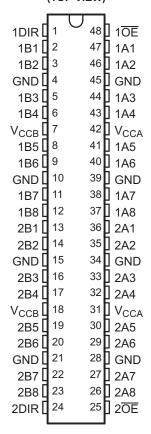


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TERMINAL ASSIGNMENTS

DGG PACKAGE (TOP VIEW)

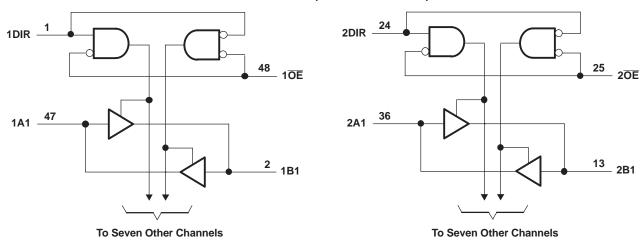


FUNCTION TABLE (EACH 8-BIT SECTION)

| INP | UTS | OPERATION |
|-----|-----|-----------------|
| ŌĒ | DIR | OPERATION |
| L | L | B data to A bus |
| L | Н | A data to B bus |
| Н | X | Isolation |



LOGIC DIAGRAM (POSITIVE LOGIC)



Pin numbers shown are for the DGG and DGV packages.

Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|------------------|---|--------------------|------|------------------------|------|
| V_{CCA} | Supply voltage range | | -0.5 | 4.6 | V |
| | | I/O ports (A port) | -0.5 | 4.6 | |
| VI | Input voltage range ⁽²⁾ | I/O ports (B port) | -0.5 | 4.6 | V |
| | | Control inputs | -0.5 | 4.6 | |
| V | Voltage range applied to any output in the high-impedance or power-off | A port | -0.5 | 4.6 | V |
| Vo | state (2) | B port | -0.5 | 4.6 | V |
| V | Valtage range applied to any output in the high or law state (2) (3) | A port | -0.5 | V _{CCA} + 0.5 | V |
| Vo | Voltage range applied to any output in the high or low state (2) (3) | B port | -0.5 | V _{CCB} + 0.5 | V |
| I _{IK} | Input clamp current | V _I < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| Io | Continuous output current | | | ±50 | mA |
| | Continuous current through V _{CCA} , V _{CCB} , or GND | | | ±100 | mA |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | DGG package | | 70 | °C/W |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

 ⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
 (3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



Recommended Operating Conditions (1) (2) (3)

over operating free-air temperature range (unless otherwise noted)

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|------------------|-------------------------------|--|------------------|------------------|-------------------------|-------------------------|------|
| V_{CCA} | Supply voltage | | | | 1.4 | 3.6 | V |
| V _{CCB} | Supply voltage | | | | 1.4 | 3.6 | V |
| | | | 1.4 V to 1.95 V | | V _{CCI} × 0.65 | | |
| V_{IH} | High-level input voltage | Data inputs | 1.95 V to 2.7 V | | 1.7 | | V |
| | | | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.4 V to 1.95 V | | | V _{CCI} × 0.35 | |
| V_{IL} | Low-level input voltage | Data inputs | 1.95 V to 2.7 V | | | 0.7 | V |
| | | | 2.7 V to 3.6 V | | | 0.8 | |
| | | | 1.4 V to 1.95 V | | V _{CCB} × 0.65 | | |
| V_{IH} | High-level input voltage | Control inputs (referenced to V _{CCB}) | 1.95 V to 2.7 V | | 1.7 | | V |
| | | (referenced to ACCB) | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.4 V to 1.95 V | | | V _{CCB} × 0.35 | |
| V_{IL} | Low-level input voltage | Control inputs (referenced to V _{CCB}) | 1.95 V to 2.7 V | | | 0.7 | V |
| | | (referenced to vCCB) | 2.7 V to 3.6 V | | | 0.8 | |
| VI | Input voltage | | | | 0 | 3.6 | V |
| | Output valtage | Active state | | | 0 | V _{cco} | V |
| V_{O} | Output voltage | 3-state | | | 0 | 3.6 | V |
| | | | | 1.4 V to 1.6 V | | -2 | |
| | LPak lavel sylvet syveset | | | 1.65 V to 1.95 V | | -4 | |
| I _{OH} | High-level output current | | | 2.3 V to 2.7 V | | -8 | mA |
| | | | | 3 V to 3.6 V | | -12 | |
| | | | | 1.4 V to 1.6 V | | 2 | |
| | Levelevel entent entered | | | 1.65 V to 1.95 V | | 4 | |
| I _{OL} | Low-level output current | | | 2.3 V to 2.7 V | | 8 | mA |
| | | | | 3 V to 3.6 V | | 12 | , |
| Δt/Δν | Input transition rise or fall | rate | | | | 5 | ns/V |
| T _A | Operating free-air tempera | ature | | | -40 | 125 | °C |

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 V_{CCI} is the V_{CC} associated with the data input port. V_{CCO} is the V_{CC} associated with the data output port. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



Electrical Characteristics (1) (2)

over operating free-air temperature range (unless otherwise noted)

| DAD | AMETER | TEST CONDI | LIONS | V | V | | -40°C to | | | 40°C to 1 | 125°C | UNIT |
|---------------------|----------------|-------------------------------|-------------------------|-------------------|-------------------|------------------------|--------------------|-------|------------------------|--------------------|-------|------|
| FAR | AIVIETER | TEST CONDI | IONS | V _{CCA} | V _{CCB} | MIN | TYP ⁽³⁾ | MAX | MIN | TYP ⁽³⁾ | MAX | UNIT |
| | | I _{OH} = -100 μA | $V_{I} = V_{IH}$ | 1.4 V to 3.6 V | 1.4 V to 3.6 V | V _{CCO} – 0.2 | | | V _{CCO} – 0.2 | | | |
| | | $I_{OH} = -2 \text{ mA}$ | $V_I = V_{IH}$ | 1.4 V | 1.4 V | 1.05 | | | 1.05 | | | |
| V _{OH} | | $I_{OH} = -4 \text{ mA}$ | $V_I = V_{IH}$ | 1.65 V | 1.65 V | 1.2 | | | 1.2 | | | V |
| | | $I_{OH} = -8 \text{ mA}$ | $V_I = V_{IH}$ | 2.3 V | 2.3 V | 1.75 | | | 1.75 | | | |
| | | $I_{OH} = -12 \text{ mA}$ | $V_{I} = V_{IH}$ | 3 V | 3 V | 2.3 | | | 2.3 | | | |
| | | I _{OH} = 100 μA | $V_{I} = V_{IL}$ | 1.4 V to 3.6 V | 1.4 V to 3.6 V | | | 0.2 | | | 0.2 | |
| . , | | $I_{OH} = 2 \text{ mA}$ | $V_I = V_{IL}$ | 1.4 V | 1.4 V | | | 0.35 | | | 0.35 | ., |
| V_{OL} | | I _{OH} = 4 mA | $V_I = V_{IL}$ | 1.65 V | 1.65 V | | | 0.45 | | | 0.45 | V |
| | | I _{OH} = 8 mA | $V_{I} = V_{IL}$ | 2.3 V | 2.3 V | | | 0.55 | | | 0.55 | |
| | | I _{OH} = 12 mA | $V_{I} = V_{IL}$ | 3 V | 3 V | | | 0.7 | | | 0.7 | |
| l _l | Control inputs | $V_I = V_{CCB}$ or GND | | 1.4 V to 3.6 V | 3.6 V | | | ±2.5 | | | ±2.5 | μА |
| | A port | \\ or\\ \\ 0 to 2 6 \\ | | 0 V | 0 to 3.6 V | | | ±10 | | | ±10 | |
| l _{off} | B port | V_I or $V_O = 0$ to 3.6 V | | 0 to 3.6 V | 0 V | | | ±10 | | | ±10 | μΑ |
| . (4) | A or B ports | $V_0 = V_{CCO}$ or GND, | OE = V _{IH} | 3.6 V | 3.6 V | | | ±12.5 | | | ±12.5 | |
| I _{OZ} (4) | B port | $V_I = V_{CCI}$ or GND | $\overline{OE} = don't$ | 0 V | 3.6 V | | | ±12.5 | | | ±12.5 | μΑ |
| | A port | | care | 3.6 V | 0 V | | | ±12.5 | | | ±12.5 | |
| | | | | 1.6 V | 1.6 V | | | 20 | | | 35 | |
| | | | | 1.95 V | 1.95 V | | | 20 | | | 35 | |
| laa. | | $V_I = V_{CCI}$ or GND, | l ₂ = 0 | 2.7 V | 2.7 V | | | 30 | | | 45 | μΑ |
| I _{CCA} | | VI = VCCI OI OIVD, | 10 – 0 | 0 V | 3.6 V | | | -40 | | | -50 | μΑ |
| | | | | 3.6 V | 0 V | | | 40 | | | 50 | |
| | | | | 3.6 V | 3.6 V | | | 40 | | | 50 | |
| | | | | 1.6 V | 1.6 V | | | 20 | | | 35 | |
| | | | | 1.95 V | 1.95 V | | | 20 | | | 35 | |
| I _{CCB} | | $V_I = V_{CCI}$ or GND, | $I_0 = 0$ | 2.7 V | 2.7 V | | | 30 | | | 45 | μА |
| ·CCR | | 1 - 100 0 0 00, | .0 = 3 | 0 V | 3.6 V | | | 40 | | | 50 | μιτ |
| | | | | 3.6 V | 0 V | | | -40 | | | -50 | |
| | | | | 3.6 V | 3.6 V | | | 40 | | | 50 | |
| Ci | Control inputs | V _I = 3.3 V or GND | | 3.3 V | 3.3 V | | 4 | | | 4 | | pF |
| C _{io} | A or B ports | $V_O = 3.3 \text{ V or GND}$ | | 3.3 V | 3.3 V | | 5 | | | 5 | | pF |

 V_{CCO} is the V_{CC} associated with the output port. V_{CCI} is the V_{CC} associated with the input port. All typical values are at T_A = 25°C. For I/O ports, the parameter I_{OZ} includes the input leakage current.



Switching Characteristics

 $T_A = -40$ °C to 85°C, $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = 1 ± 0.15 | | V _{CCB} = 2 ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|-----------------|----------------|--------------------------|-----|--------------------------------|-----|-------------------------------|-----|--------------------------|-----|------|
| | (INPUT) | (001701) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | 1.7 | 6.7 | 1.9 | 6.3 | 1.8 | 5.5 | 1.7 | 5.8 | 20 |
| t _{pd} | В | А | 1.8 | 6.8 | 2.2 | 7.4 | 2.1 | 7.6 | 2.1 | 7.3 | ns |
| | ŌE | А | 2.5 | 8.4 | 2.4 | 7.4 | 2.1 | 5.2 | 1.9 | 4.2 | 20 |
| t _{en} | OE | В | 2.1 | 9 | 2.9 | 9.8 | 3.2 | 10 | 3 | 9.8 | ns |
| 4 | ŌĒ | А | 2.2 | 6.9 | 2.3 | 6.1 | 1.3 | 3.6 | 1.3 | 3 | 20 |
| t _{dis} | OE - | В | 2.1 | 7.1 | 2.3 | 6.4 | 1.7 | 5.1 | 1.6 | 4.8 | ns |

Switching Characteristics

 $T_A = -40$ °C to 125°C, $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see Figure 2)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.15 | | V _{CCB} = 2 ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|---------|-------------|--------------------------|------|------------------------------|------|-------------------------------|------|--------------------------|------|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | 1.7 | 12.7 | 1.9 | 12.3 | 1.8 | 11.5 | 1.7 | 11.8 | 20 |
| t _{pd} | В | Α | 1.8 | 12.8 | 2.2 | 13.4 | 2.1 | 13.6 | 2.1 | 13.3 | ns |
| | ŌE | Α | 2.5 | 14.4 | 2.4 | 13.4 | 2.1 | 11.2 | 1.9 | 10.2 | |
| t _{en} | OE | В | 2.1 | 15 | 2.9 | 15.8 | 3.2 | 16 | 3 | 15.8 | ns |
| | ŌĒ | А | 2.2 | 12.9 | 2.3 | 12.1 | 1.3 | 9.6 | 1.3 | 9 | 20 |
| t _{dis} | OE | В | 2.1 | 13.1 | 2.3 | 12.4 | 1.7 | 11.1 | 1.6 | 10.8 | ns |

Switching Characteristics

 $T_A = -40$ °C to 85°C, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see Figure 2)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.15 | | V _{CCB} = 2 ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|---------|-------------|--------------------------|-----|---------------------------|-----|-------------------------------|-----|--------------------------|-----|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | 1.7 | 6.7 | 1.8 | 6 | 1.7 | 4.7 | 1.6 | 4.3 | |
| t _{pd} | В | Α | 1.4 | 5.5 | 1.8 | 6 | 1.8 | 5.8 | 1.8 | 5.5 | ns |
| | ŌĒ | Α | 2.6 | 8.5 | 2.5 | 7.5 | 2.2 | 5.3 | 1.9 | 4.2 | |
| t _{en} | OE | В | 1.8 | 7.6 | 2.6 | 7.7 | 2.6 | 7.6 | 2.6 | 7.4 | ns |
| | ŌĒ | А | 2.3 | 7 | 2.3 | 6.1 | 1.3 | 3.6 | 1.3 | 3 | |
| t _{dis} | OE . | В | 1.8 | 7 | 2.5 | 6.3 | 1.8 | 4.7 | 1.7 | 4.4 | ns |

Switching Characteristics

 $T_A = -40$ °C to 125°C, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.15 | | V _{CCB} = 2 ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|-----------------|-------------|--------------------------|------|------------------------------|------|-------------------------------|------|--------------------------|------|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | 1.7 | 12.7 | 1.8 | 12 | 1.7 | 10.7 | 1.6 | 10.3 | |
| t _{pd} | В | Α | 1.4 | 11.5 | 1.8 | 12 | 1.8 | 11.8 | 1.8 | 11.5 | ns |
| | ŌĒ | Α | 2.6 | 14.5 | 2.5 | 13.5 | 2.2 | 11.3 | 1.9 | 10.2 | |
| t _{en} | OE | В | 1.8 | 13.6 | 2.6 | 13.7 | 2.6 | 13.6 | 2.6 | 13.4 | ns |
| 1 | ŌĒ | Α | 2.3 | 13 | 2.3 | 12.1 | 1.3 | 9.6 | 1.3 | 9 | |
| t _{dis} | OE | В | 1.8 | 13 | 2.5 | 12.3 | 1.8 | 10.7 | 1.7 | 10.4 | ns |

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Switching Characteristics

 $T_A = -40$ °C to 85°C, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.15 | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = ± 0.3 | UNIT | |
|------------------|-----------------|-------------|--------------------------|-----|---------------------------|-----|-------------------------------------|-----|--------------------------|------|----|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | 1.6 | 6 | 1.8 | 5.6 | 1.5 | 4 | 1.4 | 3.4 | 20 |
| t _{pd} | В | Α | 1.3 | 4.6 | 1.7 | 4.4 | 1.5 | 4 | 1.4 | 3.7 | ns |
| | ŌĒ | А | 3.1 | 8.5 | 2.5 | 7.5 | 2.2 | 5.3 | 1.9 | 4.2 | |
| t _{en} | OE | В | 1.7 | 5.7 | 2.2 | 5.5 | 2.2 | 5.3 | 2.2 | 5.1 | ns |
| | ŌĒ | А | 2.4 | 7 | 3 | 6.1 | 1.4 | 3.6 | 1.2 | 3 | 20 |
| t _{dis} | OE | В | 1.2 | 5.8 | 1.9 | 5 | 1.4 | 3.6 | 1.3 | 3.3 | ns |

Switching Characteristics

 $T_A = -40$ °C to 125°C, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Figure 2)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.15 | | V _{CCB} = 2 ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|---------|-------------|--------------------------|------|---------------------------|------|-------------------------------|------|--------------------------|------|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | Α | В | 1.6 | 12 | 1.8 | 11.6 | 1.5 | 10 | 1.4 | 9.4 | 20 |
| t _{pd} | В | Α | 1.3 | 10.6 | 1.7 | 10.4 | 1.5 | 10 | 1.4 | 9.7 | ns |
| | ŌE | Α | 3.1 | 14.5 | 2.5 | 13.5 | 2.2 | 11.3 | 1.9 | 10.2 | |
| t _{en} | OE | В | 1.7 | 11.7 | 2.2 | 11.5 | 2.2 | 11.3 | 2.2 | 11.1 | ns |
| | ŌĒ | А | 2.4 | 13 | 3 | 12.1 | 1.4 | 9.6 | 1.2 | 9 | 20 |
| t _{dis} | OE | В | 1.2 | 11.8 | 1.9 | 11 | 1.4 | 9.6 | 1.3 | 9.3 | ns |

Switching Characteristics

 $T_A = -40$ °C to 85°C, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see Figure 2)

| PARAMETER | FROM | TO (OUTPUT) | | V _{CCB} = 1.5 V ± 0.1 V | | V _{CCB} = 1.8 V ± 0.15 V | | 2.5 V V | V _{CCB} = 3.3 V ± 0.3 V | | UNIT |
|------------------|---------|-------------|-----|-------------------------------------|-----|--------------------------------------|-----|------------|-------------------------------------|-----|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| • | Α | В | 1.5 | 5.9 | 1.7 | 5.4 | 1.5 | 3.7 | 1.4 | 3.1 | |
| t _{pd} | В | А | 1.3 | 4.5 | 1.6 | 3.8 | 1.5 | 3.3 | 1.4 | 3.1 | ns |
| | ŌĒ | А | 2.6 | 8.3 | 2.5 | 7.4 | 2.2 | 5.2 | 1.9 | 4.1 | 20 |
| t _{en} | OE | В | 1.6 | 4.9 | 2 | 4.5 | 2 | 4.3 | 1.9 | 4.1 | ns |
| | ŌĒ | Α | 2.3 | 7 | 3 | 6 | 1.3 | 3.5 | 1.2 | 3.5 | 20 |
| t _{dis} | OE | В | 1.3 | 6.9 | 2.1 | 5.5 | 1.6 | 3.8 | 1.5 | 3.5 | ns |

Switching Characteristics

 $T_A = -40^{\circ}\text{C}$ to 125°C, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see Figure 2)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.15 | | V _{CCB} = 2 ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT | |
|------------------|---------|-------------|--------------------------|------|------------------------------|------|-------------------------------|------|--------------------------|------|------|--|
| | (INPUT) | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | А | В | 1.5 | 11.9 | 1.7 | 11.4 | 1.5 | 9.7 | 1.4 | 9.1 | | |
| t _{pd} | В | А | 1.3 | 10.5 | 1.6 | 9.8 | 1.5 | 9.3 | 1.4 | 9.1 | ns | |
| | ŌĒ | А | 2.6 | 14.3 | 2.5 | 13.4 | 2.2 | 11.2 | 1.9 | 10.1 | 20 | |
| t _{en} | OE | В | 1.6 | 10.9 | 2 | 10.5 | 2 | 10.3 | 1.9 | 10.1 | ns | |
| | ŌĒ | А | 2.3 | 13 | 3 | 12 | 1.3 | 9.5 | 1.2 | 9.5 | | |
| t _{dis} | OE | В | 1.3 | 12.9 | 2.1 | 11.5 | 1.6 | 9.8 | 1.5 | 9.5 | ns | |

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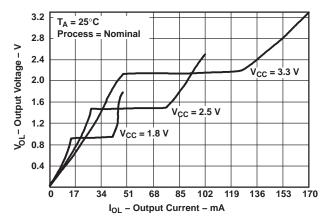
Operating Characteristics

 V_{CCA} and V_{CCB} = 3.3 V, T_A = 25°C

| | PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|---------------------|--|------------------|----------------------------------|-----|------|
| | Power dissipation capacitance per transceiver, | Outputs enabled | | 14 | pF |
| C _{pdA} | A-port input, B-port output | Outputs disabled | C 0 f 10 MHz | 7 | |
| $C_{pdA} (V_{CCA})$ | Power dissipation capacitance per transceiver, | Outputs enabled | $C_L = 0$, $f = 10 \text{ MHz}$ | 20 | |
| | B-port input, A-port output | Outputs disabled | | 7 | |
| | Power dissipation capacitance per transceiver, | Outputs enabled | | 20 | |
| C _{pdB} | A-port input, B-port output | Outputs disabled | $C_1 = 0$. $f = 10 \text{ MHz}$ | 7 | |
| $C_{pdB} (V_{CCB})$ | Power dissipation capacitance per transceiver, | Outputs enabled | $C_L = 0$, $f = 10 \text{ MHz}$ | 14 | pF |
| | B-port input, A-port output | Outputs disabled | | 7 | |

Output Description

The DOCTM circuitry is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical V_{OL} vs I_{OL} and V_{OH} vs I_{OH} curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, AVC Logic Family Technology and Applications, literature number SCEA006, and Dynamic Output Control (DOCTM) Circuitry Technology and Applications, literature number SCEA009.



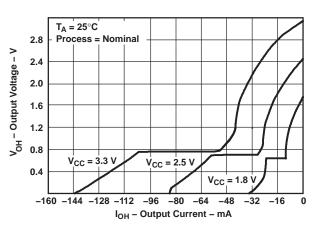
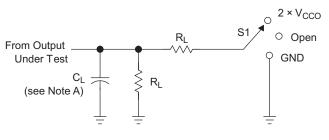


Figure 1. Typical Output Voltage vs Output Current

 V_{CCB}



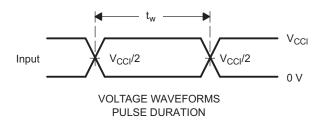
PARAMETER MEASUREMENT INFORMATION



| TEST | S1 |
|------------------------------------|----------------------|
| t _{pd} | Open |
| t _{PLZ} /t _{PZL} | 2 × V _{CCO} |
| t _{PHZ} /t _{PZH} | GND |

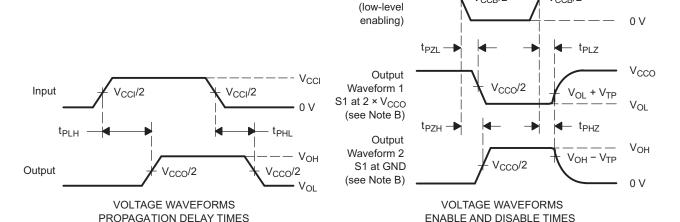
LOAD CIRCUIT

| V _{CCO} | C _L | R _L | V _{TP} |
|------------------|----------------|----------------|-----------------|
| 1.5 V ± 0.1 V | 15 pF | 500 Ω | 0.1 V |
| 1.8 V ± 0.15 V | 30 pF | 500 Ω | 0.15 V |
| 2.5 V ± 0.2 V | 30 pF | 500 Ω | 0.15 V |
| 3.3 V ± 0.3 V | 30 pF | 500 Ω | 0.3 V |



V_{CCB}/2

V_{CCB}/2



Output Control

- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR 10 MHz, Z_O = 50 Ω, dv/dt ≥ 1 V/ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en}.
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. V_{CCI} is the V_{CC} associated with the input port.
 - I. V_{CCO} is the V_{CC} associated with the output port.

Figure 2. Load Circuit and Voltage Waveforms



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PACKAGING INFORMATION

| Orderable Device | Status | Package Type Package F | | Pins | Package Qty | Eco Plan | Lead/Ball Finish | MSL Peak Temp | Op Temp (°C) | Top-Side Markings | Samples |
|--------------------|--------|------------------------|---------|------|-------------|----------------------------|------------------|---------------------|--------------|-------------------|---------|
| | (1) | | Drawing | | | (2) | | (3) | | (4) | |
| CAVCB164245QDGGRQ1 | ACTIVE | TSSOP | DGG | 48 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-3-260C-168 HR | -40 to 125 | AVCB164245Q | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ Only one of markings shown within the brackets will appear on the physical device.

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OTHER QUALIFIED VERSIONS OF SN74AVCB164245-Q1:

Catalog: SN74AVCB164245

Enhanced Product: SN74AVCB164245-EP





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NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Enhanced Product Supports Defense, Aerospace and Medical Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| | Dimension designed to accommodate the component width |
|----|---|
| | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CAVCB164245QDGGRQ1 | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 15.8 | 1.8 | 12.0 | 24.0 | Q1 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CAVCB164245QDGGRQ1 | TSSOP | DGG | 48 | 2000 | 367.0 | 367.0 | 45.0 |

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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